

N-channel TrenchMOS™ transistor**IRF530N****FEATURES**

- 'Trench' technology
- Low on-state resistance
- Fast switching
- Low thermal resistance

SYMBOL**QUICK REFERENCE DATA**

$$V_{DSS} = 100 \text{ V}$$

$$I_D = 17 \text{ A}$$

$$R_{DS(ON)} \leq 110 \text{ m}\Omega$$

GENERAL DESCRIPTION

N-channel enhancement mode field-effect power transistor in a plastic envelope using 'trench' technology.

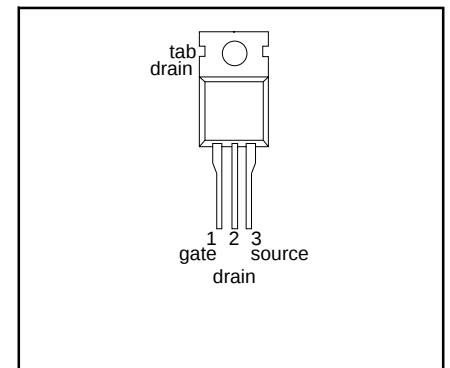
Applications:-

- d.c. to d.c. converters
- switched mode power supplies

The IRF530N is supplied in the SOT78 (TO220AB) conventional leaded package.

PINNING

PIN	DESCRIPTION
1	gate
2	drain
3	source
tab	drain

SOT78 (TO220AB)**LIMITING VALUES**

Limiting values in accordance with the Absolute Maximum System (IEC 134)

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
V_{DSS}	Drain-source voltage	$T_j = 25^\circ\text{C}$ to 175°C	-	100	V
V_{DGR}	Drain-gate voltage	$T_j = 25^\circ\text{C}$ to 175°C ; $R_{GS} = 20 \text{ k}\Omega$	-	100	V
V_{GS}	Gate-source voltage		-	± 20	V
I_D	Continuous drain current	$T_{mb} = 25^\circ\text{C}$; $V_{GS} = 10 \text{ V}$	-	17	A
		$T_{mb} = 100^\circ\text{C}$; $V_{GS} = 10 \text{ V}$	-	12	A
I_{DM}	Pulsed drain current	$T_{mb} = 25^\circ\text{C}$	-	68	A
P_D	Total power dissipation	$T_{mb} = 25^\circ\text{C}$	-	79	W
T_j, T_{stg}	Operating junction and storage temperature		- 55	175	$^\circ\text{C}$

AVALANCHE ENERGY LIMITING VALUES

Limiting values in accordance with the Absolute Maximum System (IEC 134)

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
E_{AS}	Non-repetitive avalanche energy	Unclamped inductive load, $I_{AS} = 7.8 \text{ A}$; $t_p = 300 \mu\text{s}$; T_j prior to avalanche = 25°C ; $V_{DD} \leq 25 \text{ V}$; $R_{GS} = 50 \Omega$; $V_{GS} = 10 \text{ V}$; refer to fig:14	-	150	mJ
I_{AS}	Peak non-repetitive avalanche current		-	17	A

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THERMAL RESISTANCES

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
$R_{th\ j-mb}$	Thermal resistance junction to mounting base		-	-	1.9	K/W
$R_{th\ j-a}$	Thermal resistance junction to ambient	SOT78 package, in free air	-	60	-	K/W

ELECTRICAL CHARACTERISTICS

 $T_j = 25^\circ\text{C}$ unless otherwise specified

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
$V_{(BR)DSS}$	Drain-source breakdown voltage	$V_{GS} = 0\text{ V}$; $I_D = 0.25\text{ mA}$; $T_j = -55^\circ\text{C}$	100 89	-	-	V V
$V_{GS(TO)}$	Gate threshold voltage	$V_{DS} = V_{GS}$; $I_D = 1\text{ mA}$; $T_j = 175^\circ\text{C}$ $T_j = -55^\circ\text{C}$	2 1 -	3 -	4 -	V V V
$R_{DS(ON)}$	Drain-source on-state resistance	$V_{GS} = 10\text{ V}$; $I_D = 9\text{ A}$; $T_j = 175^\circ\text{C}$	- -	80 -	110 275	m Ω m Ω
g_{fs}	Forward transconductance	$V_{DS} = 25\text{ V}$; $I_D = 9\text{ A}$	6.4	11	-	S
I_{GSS}	Gate source leakage current	$V_{GS} = \pm 20\text{ V}$; $V_{DS} = 0\text{ V}$	-	10	100	nA
I_{DSS}	Zero gate voltage drain current	$V_{DS} = 100\text{ V}$; $V_{GS} = 0\text{ V}$; $V_{DS} = 80\text{ V}$; $V_{GS} = 0\text{ V}$; $T_j = 175^\circ\text{C}$	- -	0.05 -	10 250	μA μA
$Q_{g(tot)}$	Total gate charge	$I_D = 9\text{ A}$; $V_{DD} = 80\text{ V}$; $V_{GS} = 10\text{ V}$	-	-	40	nC
Q_{gs}	Gate-source charge		-	-	5.6	nC
Q_{gd}	Gate-drain (Miller) charge		-	-	19	nC
$t_{d\ on}$	Turn-on delay time	$V_{DD} = 50\text{ V}$; $R_D = 2.7\ \Omega$; $V_{GS} = 10\text{ V}$; $R_G = 5.6\ \Omega$	-	6	-	ns
t_r	Turn-on rise time		-	36	-	ns
$t_{d\ off}$	Turn-off delay time	Resistive load	-	18	-	ns
t_f	Turn-off fall time		-	12	-	ns
L_d	Internal drain inductance	Measured tab to centre of die	-	3.5	-	nH
L_d	Internal drain inductance	Measured from drain lead to centre of die (SOT78 package only)	-	4.5	-	nH
L_s	Internal source inductance	Measured from source lead to source bond pad	-	7.5	-	nH
C_{iss}	Input capacitance	$V_{GS} = 0\text{ V}$; $V_{DS} = 25\text{ V}$; $f = 1\text{ MHz}$	-	633	-	pF
C_{oss}	Output capacitance		-	103	-	pF
C_{rss}	Feedback capacitance		-	61	-	pF

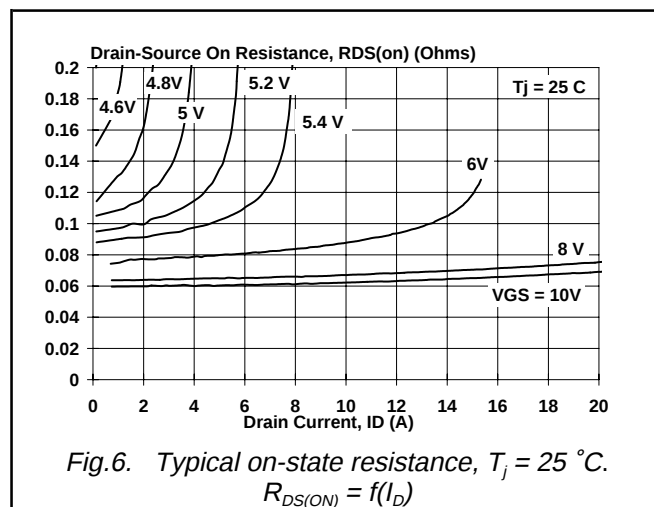
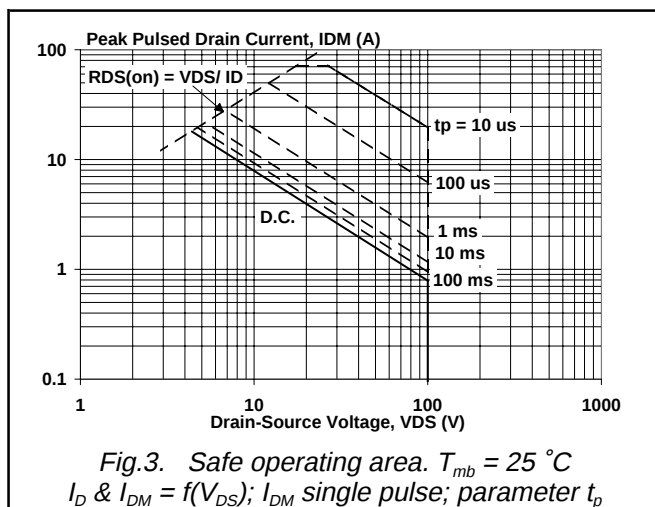
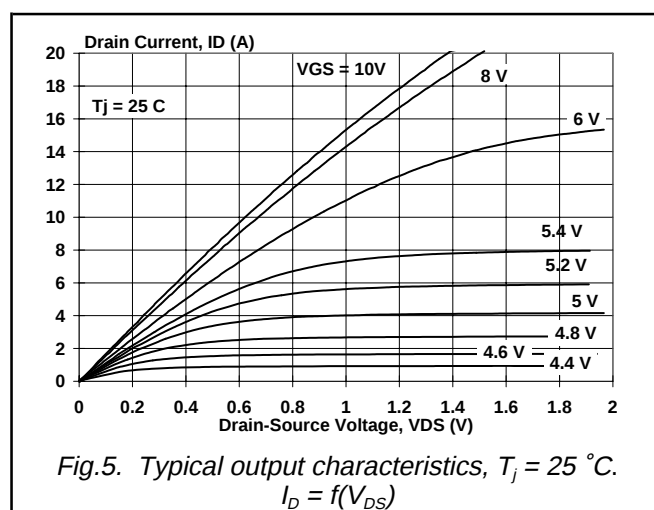
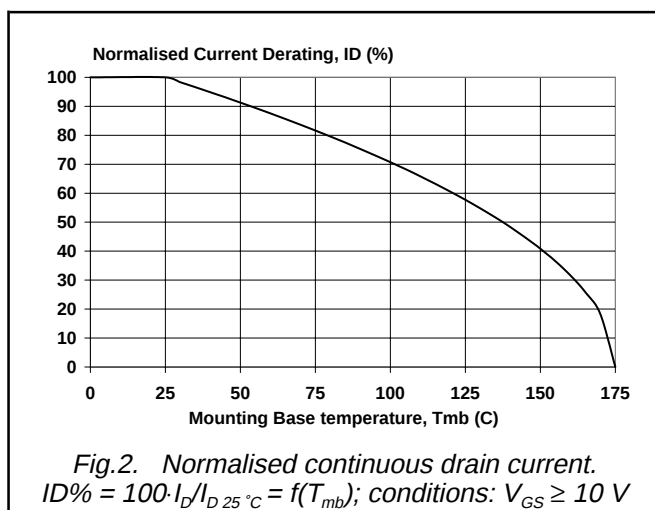
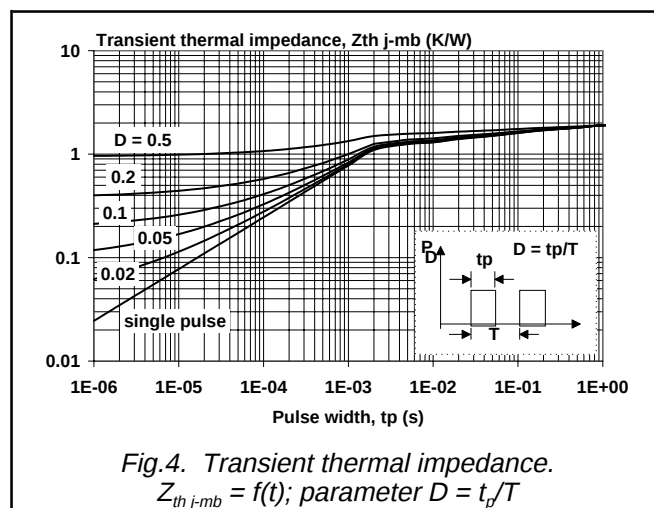
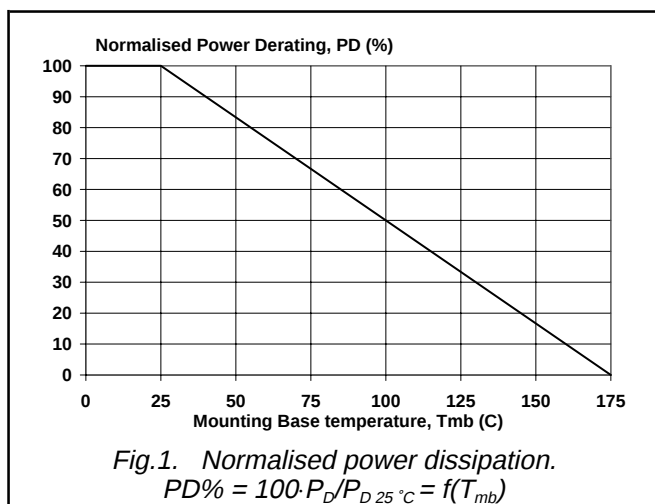
REVERSE DIODE LIMITING VALUES AND CHARACTERISTICS

 $T_j = 25^\circ\text{C}$ unless otherwise specified

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
I_S	Continuous source current (body diode)		-	-	17	A
I_{SM}	Pulsed source current (body diode)		-	-	68	A
V_{SD}	Diode forward voltage	$I_F = 17\text{ A}$; $V_{GS} = 0\text{ V}$	-	0.92	1.2	V
t_{rr}	Reverse recovery time	$I_F = 17\text{ A}$; $-dI_F/dt = 100\text{ A}/\mu\text{s}$; $V_{GS} = 0\text{ V}$; $V_R = 25\text{ V}$	-	55	-	ns
Q_{rr}	Reverse recovery charge		-	135	-	nC

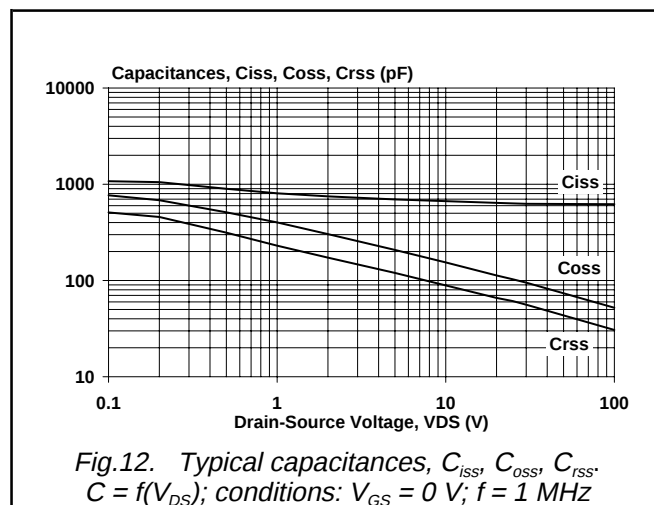
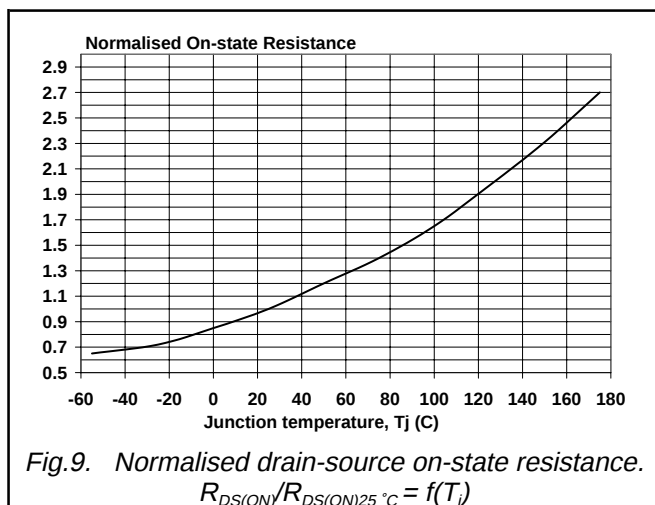
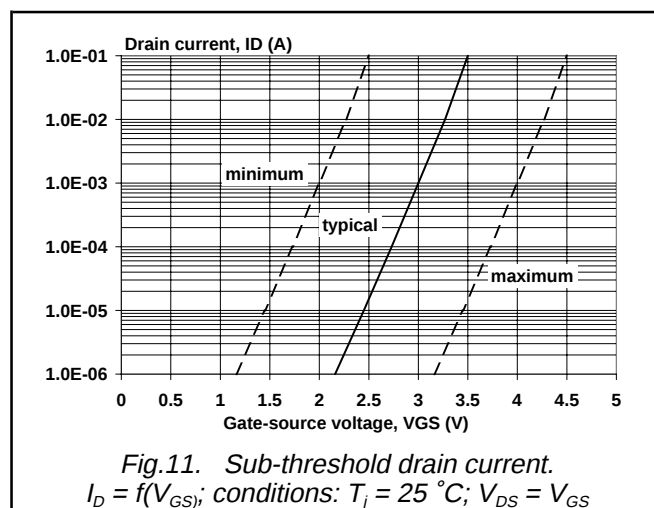
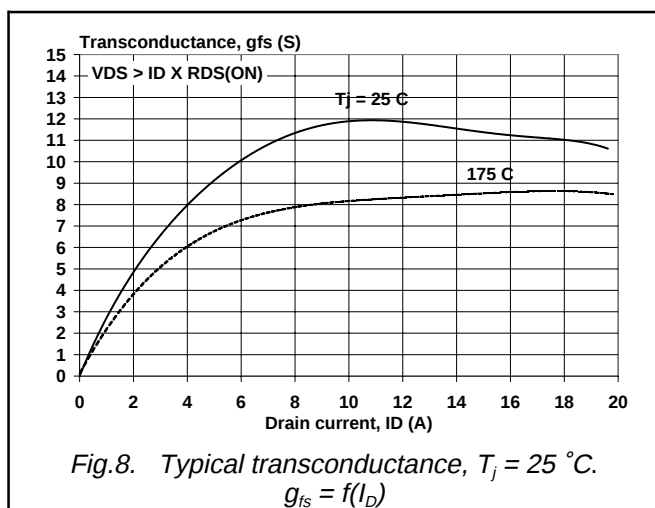
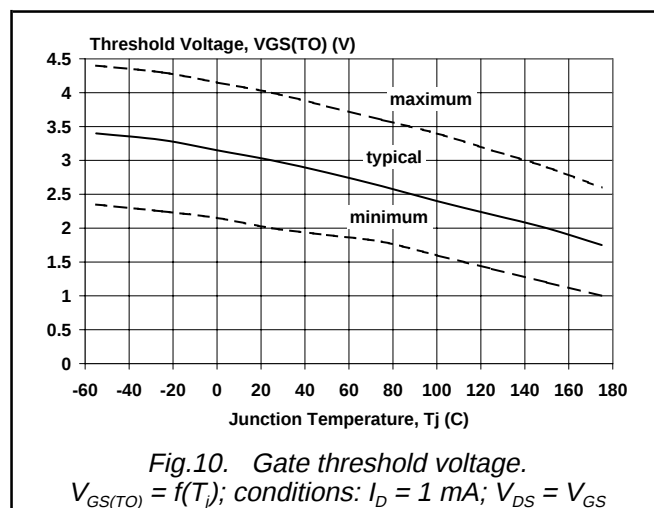
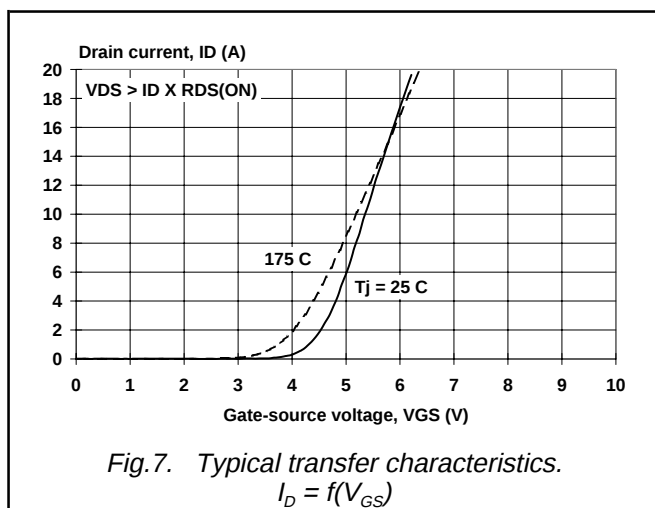
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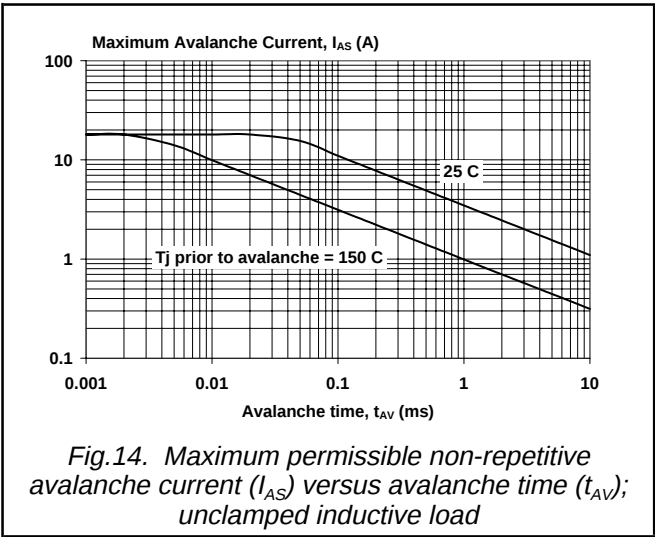
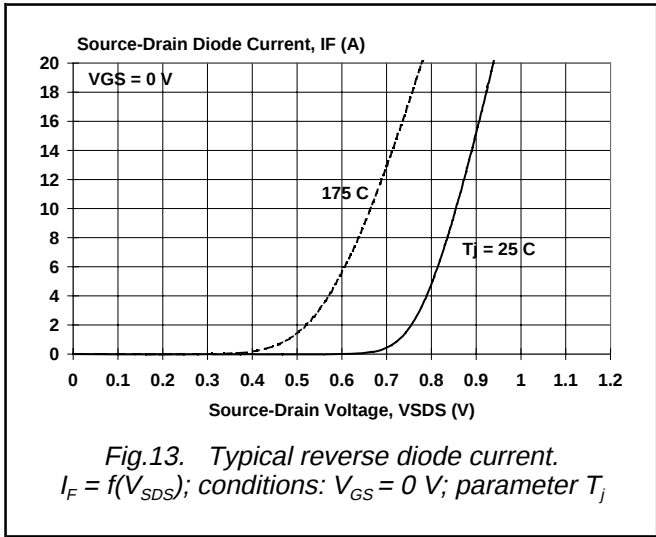
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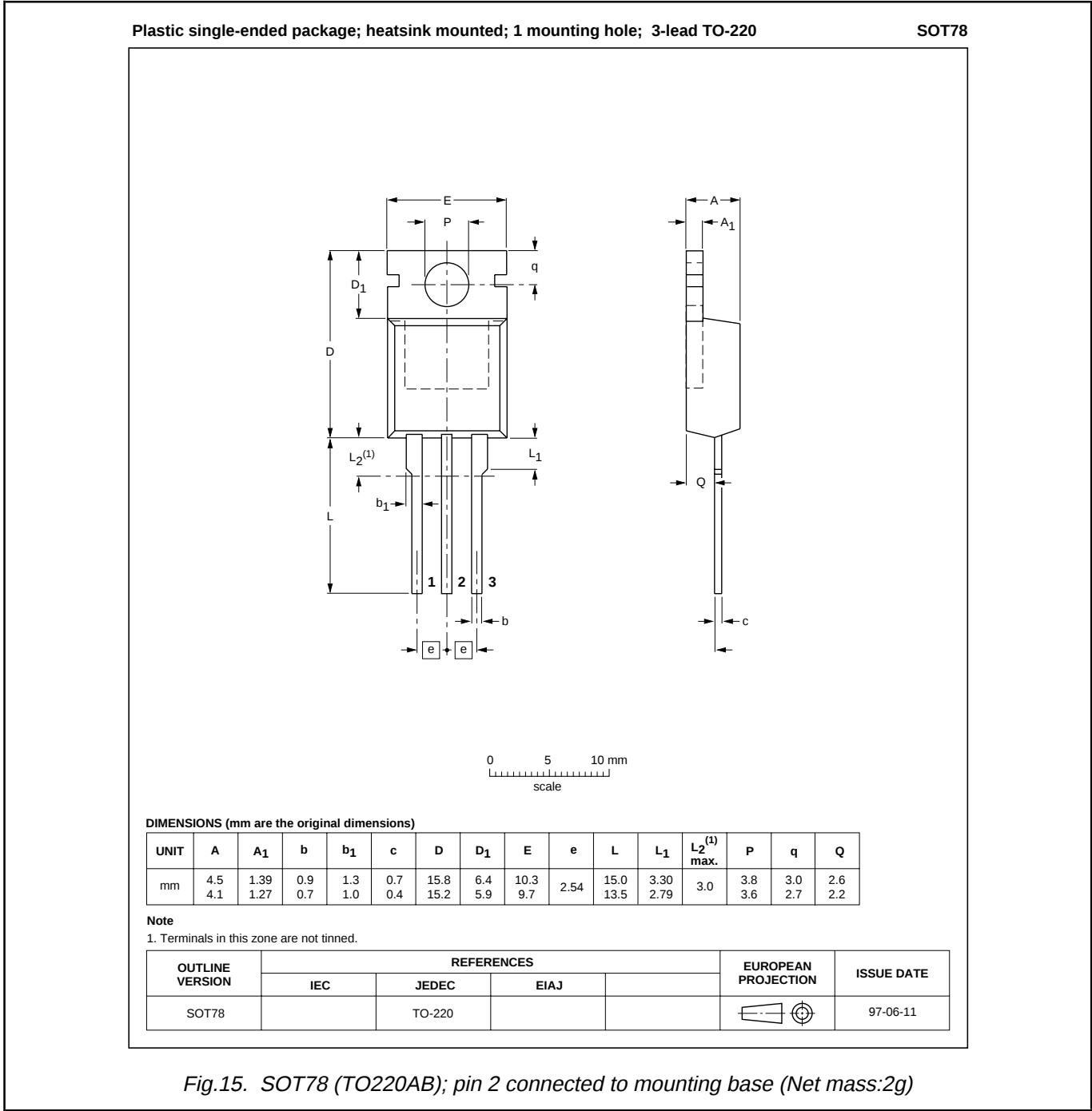


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MECHANICAL DATA



Notes

1. This product is supplied in anti-static packaging. The gate-source input must be protected against static discharge during transport or handling.
2. Refer to mounting instructions for SOT78 (TO220AB) package.
3. Epoxy meets UL94 V0 at 1/8".

N-channel TrenchMOSTM transistor

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DEFINITIONS

Data sheet status	
Objective specification	This data sheet contains target or goal specifications for product development.
Preliminary specification	This data sheet contains preliminary data; supplementary data may be published later.
Product specification	This data sheet contains final product specifications.
Limiting values	
Limiting values are given in accordance with the Absolute Maximum Rating System (IEC 134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of this specification is not implied. Exposure to limiting values for extended periods may affect device reliability.	
Application information	
Where application information is given, it is advisory and does not form part of the specification.	
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